## Low Loss DuoPack : IGBT in TRENCHSTOP ${ }^{\text {TM }}$ and Fieldstop technology with soft, fast recovery anti-parallel Emitter Controlled HE diode



Features:

- Very low $\mathrm{V}_{\text {CE(sat) }} 1.5 \mathrm{~V}$ (typ.)
- Maximum Junction Temperature $175^{\circ} \mathrm{C}$
- $\quad$ Short circuit withstand time $5 \mu \mathrm{~s}$
- Designed for :

Frequency Converters

- Uninterrupted Power Supply
- TRENCHSTOP ${ }^{\text {TM }}$ and Fieldstop technology for 600 V applications offers :
- very tight parameter distribution
- high ruggedness, temperature stable behavior
- very high switching speed
- Positive temperature coefficient in $\mathrm{V}_{\mathrm{CE} \text { (sat) }}$
- Low EM

- Pb-free lead plating; RoHS compliant
- Very soft, fast recovery anti-parallel Emitter Controlled HE diode
- Qualified according to JEDEC ${ }^{1}$ for target applications
- Complete product spectrum and PSpice Models : http://www.infineon.com/igbt/

| Type | $V_{\mathrm{CE}}$ | $I_{\mathrm{C}}$ | $V_{\mathrm{CE}(\text { sat }), T_{j}=25^{\circ} \mathrm{C}}$ | $T_{\mathrm{j}, \max }$ | Marking Code | Package |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| IKP15N60T | 600 V | 15 A | 1.5 V | $175^{\circ} \mathrm{C}$ | K 15 T 60 | PG-TO220-3 |

## Maximum Ratings

| Parameter | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Collector-emitter voltage, $T_{j} \geq 25^{\circ} \mathrm{C}$ | $V_{\text {CE }}$ | 600 | V |
| DC collector current, limited by $T_{\text {jmax }}$ $T_{\mathrm{C}}=25^{\circ} \mathrm{C}$, value limited by bondwire $T_{\mathrm{C}}=100^{\circ} \mathrm{C}$ | Ic | $\begin{aligned} & 26 \\ & 23 \end{aligned}$ | A |
| Pulsed collector current, $t_{\mathrm{p}}$ limited by $T_{\mathrm{jmax}}$ | $I_{\text {Cpuls }}$ | 45 |  |
| Turn off safe operating area, $V_{\text {CE }}=600 \mathrm{~V}, T_{\mathrm{j}}=175^{\circ} \mathrm{C}, t_{\mathrm{p}}=1 \mu \mathrm{~s}$ | - | 45 |  |
| Diode forward current, limited by $T_{\text {jmax }}$ $T_{\mathrm{C}}=25^{\circ} \mathrm{C}$, value limited by bondwire $T_{\mathrm{C}}=100^{\circ} \mathrm{C}$ | $I_{\text {F }}$ | $\begin{aligned} & 26 \\ & 23 \end{aligned}$ |  |
| Diode pulsed current, $t_{\mathrm{p}}$ limited by $T_{\mathrm{jmax}}$ | $I_{\text {Fpuls }}$ | 45 |  |
| Gate-emitter voltage | $V_{G E}$ | $\pm 20$ | V |
| Short circuit withstand time ${ }^{2)}$ $V_{\mathrm{GE}}=15 \mathrm{~V}, V_{\mathrm{CC}} \leq 400 \mathrm{~V}, T_{\mathrm{j}} \leq 150^{\circ} \mathrm{C}$ | $t_{\text {sc }}$ | 5 | $\mu \mathrm{S}$ |
| Power dissipation $T_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $P_{\text {tot }}$ | 130 | W |
| Operating junction temperature | $T_{\mathrm{j}}$ | -40...+175 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature | $T_{\text {stg }}$ | $-55 \ldots+150$ |  |
| Soldering temperature wavesoldering, 1.6 mm ( 0.063 in .) from case for 10 s |  | 260 |  |

[^0]Thermal Resistance

| Parameter | Symbol | Conditions | Max. Value | Unit |
| :--- | :--- | :---: | :---: | :---: |
| Characteristic <br> IGBT thermal resistance, <br> junction - case$R_{\mathrm{thJC}}$ |  |  |  |  |
| Diode thermal resistance, <br> junction - case | $R_{\mathrm{thJCD}}$ |  | 1.15 | K/W |
| Thermal resistance, <br> junction - ambient | $R_{\mathrm{thJA}}$ |  | 62 |  |

Electrical Characteristic, at $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min. | Typ. | max. |  |
| Static Characteristic |  |  |  |  |  |  |
| Collector-emitter breakdown voltage | $V_{\text {(BR)CES }}$ | $V_{\mathrm{GE}}=0 \mathrm{~V}, I_{\mathrm{C}}=0.2 \mathrm{~mA}$ | 600 | - | - | V |
| Collector-emitter saturation voltage | $V_{\text {CE(sat) }}$ | $\begin{aligned} & V_{\mathrm{GE}}=15 \mathrm{~V}, \quad I_{\mathrm{C}}=15 \mathrm{~A} \\ & T_{\mathrm{j}}=25^{\circ} \mathrm{C} \\ & T_{\mathrm{j}}=175^{\circ} \mathrm{C} \end{aligned}$ | - | $\begin{aligned} & 1.5 \\ & 1.9 \end{aligned}$ | $2.05$ |  |
| Diode forward voltage | $V_{F}$ | $\begin{aligned} & V_{\mathrm{GE}}=0 \mathrm{~V}, I_{\mathrm{F}}=15 \mathrm{~A} \\ & T_{\mathrm{j}}=25^{\circ} \mathrm{C} \\ & T_{\mathrm{j}}=175^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |  | $\begin{gathered} 1.65 \\ 1.6 \end{gathered}$ | $2.05$ |  |
| Gate-emitter threshold voltage | $V_{G E(t h)}$ | $I_{\mathrm{C}}=210 \mu \mathrm{~A}, V_{\mathrm{CE}}=V_{\mathrm{GE}}$ | 4.1 | 4.9 | 5.7 |  |
| Zero gate voltage collector current | $I_{\text {CES }}$ | $\begin{aligned} & V_{\mathrm{CE}}=600 \mathrm{~V}, \\ & V_{\mathrm{GE}}=0 \mathrm{~V} \\ & T_{\mathrm{j}}=25^{\circ} \mathrm{C} \\ & T_{\mathrm{j}}=175^{\circ} \mathrm{C} \end{aligned}$ | - | - | $\begin{gathered} 40 \\ 1000 \end{gathered}$ | $\mu \mathrm{A}$ |
| Gate-emitter leakage current | $I_{\text {GES }}$ | $V_{\mathrm{CE}}=0 \mathrm{~V}, V_{\mathrm{GE}}=20 \mathrm{~V}$ | - | - | 100 | nA |
| Transconductance | $g_{\text {fs }}$ | $V_{C E}=20 \mathrm{~V}, I_{\text {C }}=15 \mathrm{~A}$ | - | 8.7 | - | S |
| Integrated gate resistor | $R_{\text {Gint }}$ |  |  | - |  | $\Omega$ |

## Dynamic Characteristic

| Input capacitance | $C_{\text {iss }}$ | $\begin{aligned} & V_{\mathrm{CE}}=25 \mathrm{~V}, \\ & V_{\mathrm{GE}}=0 \mathrm{~V}, \\ & f=1 \mathrm{MHz} \end{aligned}$ | - | 860 | - | pF |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output capacitance | $C_{\text {oss }}$ |  | - | 55 | - |  |
| Reverse transfer capacitance | $C_{\text {rss }}$ |  | - | 24 | - |  |
| Gate charge | $Q_{\text {Gate }}$ | $\begin{aligned} & V_{\mathrm{CC}}=480 \mathrm{~V}, I_{\mathrm{C}}=15 \mathrm{~A} \\ & V_{\mathrm{GE}}=15 \mathrm{~V} \end{aligned}$ | - | 87 | - | nC |
| Internal emitter inductance measured 5 mm ( 0.197 in.) from case | $L_{E}$ |  | - | 7 | - | nH |
| Short circuit collector current ${ }^{1)}$ | $I_{\text {C(SC) }}$ | $\begin{aligned} & V_{\mathrm{GE}}=15 \mathrm{~V}, t_{\mathrm{SC}} \leq 5 \mu \mathrm{~S} \\ & V_{\mathrm{CC}}=400 \mathrm{~V}, \\ & T_{\mathrm{j}} \leq 150^{\circ} \mathrm{C} \end{aligned}$ | - | 137.5 | - | A |

${ }^{1)}$ Allowed number of short circuits: <1000; time between short circuits: $>1 \mathrm{~s}$.

Switching Characteristic, Inductive Load, at $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$

| Parameter | Symbol | Conditions | Value |  |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min. | Typ. | max. |  |

## IGBT Characteristic

| Turn-on delay time | $t_{\text {d }(\text { on) }}$ | $\begin{aligned} & T_{\mathrm{j}}=25^{\circ} \mathrm{C}, \\ & V_{\mathrm{CC}}=400 \mathrm{~V}, I_{\mathrm{C}}=15 \mathrm{~A}, \\ & V_{\mathrm{GE}}=0 / 15 \mathrm{~V}, r_{\mathrm{G}}=15 \Omega, \\ & L_{\sigma}=154 \mathrm{nH}, C_{\sigma}=39 \mathrm{pF} \end{aligned}$ | - | 17 | - | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Rise time | $t_{\mathrm{r}}$ |  | - | 11 | - |  |
| Turn-off delay time | $t_{\text {d (off) }}$ |  | - | 188 | - |  |
| Fall time | $t_{\mathrm{f}}$ |  | - | 50 | - |  |
| Turn-on energy | $E_{\text {on }}$ | $L_{\sigma}, C_{\sigma}$ from Fig. E Energy losses include | - | 0.22 | - | mJ |
| Turn-off energy | $E_{\text {off }}$ | "tail" and diode reverse | - | 0.35 | - |  |
| Total switching energy | $E_{\text {ts }}$ | recovery. | - | 0.57 | - |  |

## Anti-Parallel Diode Characteristic

| Diode reverse recovery time | $t_{\text {rr }}$ | $\begin{aligned} & T_{\mathrm{j}}=25^{\circ} \mathrm{C}, \\ & V_{\mathrm{R}}=400 \mathrm{~V}, I_{\mathrm{F}}=15 \mathrm{~A}, \\ & d i_{\mathrm{F}} / d t=825 \mathrm{~A} / \mu \mathrm{s} \end{aligned}$ | - | 34 | - | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Diode reverse recovery charge | $Q_{\text {rr }}$ |  | - | 0.24 | - | $\mu \mathrm{C}$ |
| Diode peak reverse recovery current | $I_{\text {rrm }}$ |  | - | 10.4 | - | A |
| Diode peak rate of fall of reverse recovery current during $t_{\mathrm{b}}$ | $d i_{\text {rr }} / d t$ |  | - | 718 | - | A/ $\mu \mathrm{s}$ |

Switching Characteristic, Inductive Load, at $T_{\mathrm{j}}=175^{\circ} \mathrm{C}$

| Parameter | Symbol | Conditions | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min. | Typ. | max. |  |
| IGBT Characteristic |  |  |  |  |  |  |
| Turn-on delay time | $t_{\text {d }(\text { on })}$ | $\begin{aligned} & T_{\mathrm{j}}=175^{\circ} \mathrm{C}, \\ & V_{\mathrm{CC}}=400 \mathrm{~V}, I_{\mathrm{C}}=15 \mathrm{~A}, \\ & V_{\mathrm{GE}}=0 / 15 \mathrm{~V}, r_{\mathrm{G}}=15 \Omega, \\ & L_{\sigma}=154 \mathrm{nH}, C_{\sigma}=39 \mathrm{pF} \end{aligned}$ <br> $L_{\sigma}, C_{\sigma}$ from Fig. E Energy losses include "tail" and diode reverse recovery. | - | 17 | - | ns |
| Rise time | $t_{\mathrm{r}}$ |  | - | 15 | - |  |
| Turn-off delay time | $t_{\text {d ( off) }}$ |  | - | 212 | - |  |
| Fall time | $t_{\mathrm{f}}$ |  | - | 79 | - |  |
| Turn-on energy | $E_{\text {on }}$ |  | - | 0.34 | - | mJ |
| Turn-off energy | $E_{\text {off }}$ |  | - | 0.47 | - |  |
| Total switching energy | $E_{\text {ts }}$ |  | - | 0.81 | - |  |

## Anti-Parallel Diode Characteristic

| Diode reverse recovery time | $t_{\text {rr }}$ | $\begin{aligned} & T_{\mathrm{j}}=175^{\circ} \mathrm{C} \\ & V_{\mathrm{R}}=400 \mathrm{~V}, I_{\mathrm{F}}=15 \mathrm{~A}, \\ & d i_{\mathrm{F}} / d t=825 \mathrm{~A} / \mu \mathrm{s} \end{aligned}$ | - | 140 | - | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Diode reverse recovery charge | $Q_{\text {rr }}$ |  | - | 1.0 | - | $\mu \mathrm{C}$ |
| Diode peak reverse recovery current | $I_{\text {rrm }}$ |  | - | 14.7 | - | A |
| Diode peak rate of fall of reverse recovery current during $t_{\mathrm{b}}$ | $d i_{r r} / d t$ |  | - | 495 | - | A/ $\mu \mathrm{s}$ |


$f$, SWITCHING FREQUENCY
Figure 1. Collector current as a function of switching frequency
$\left(T_{\mathrm{j}} \leq 175^{\circ} \mathrm{C}, D=0.5, V_{\mathrm{CE}}=400 \mathrm{~V}\right.$, $V_{G E}=0 / 15 \mathrm{~V}, r_{\mathrm{G}}=15 \Omega$ )

$T_{\mathrm{C}}$, CASE TEMPERATURE
Figure 3. Power dissipation as a function of case temperature
( $T_{\mathrm{j}} \leq 175^{\circ} \mathrm{C}$ )

$V_{\text {CE }}$, COLLECTOR-EMITTER VOLTAGE
Figure 2. Safe operating area
( $D=0, T_{\mathrm{C}}=25^{\circ} \mathrm{C}, T_{\mathrm{j}} \leq 175^{\circ} \mathrm{C}$;
$V_{\mathrm{GE}}=0 / 15 \mathrm{~V}$ )

$T_{\mathrm{C}}$, CASE TEMPERATURE
Figure 4. Collector current as a function of case temperature
$\left(V_{\mathrm{GE}} \geq 15 \mathrm{~V}, T_{\mathrm{j}} \leq 175^{\circ} \mathrm{C}\right)$

$V_{\text {CE }}$, COLLECTOR-EMITTER VOLTAGE
Figure 5. Typical output characteristic ( $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$ )

$V_{\text {CE }}$, COLLECTOR-EMITTER VOLTAGE
Figure 6. Typical output characteristic
$\left(T_{j}=175^{\circ} \mathrm{C}\right)$

$V_{\mathrm{GE}}$, GATE-EMITTER VOLTAGE
Figure 7. Typical transfer characteristic ( $\mathrm{V}_{\mathrm{CE}}=20 \mathrm{~V}$ )


Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature
( $V_{G E}=15 \mathrm{~V}$ )

$I_{C}$, COLLECTOR CURRENT
Figure 9. Typical switching times as a function of collector current (inductive load, $T_{\mathrm{J}}=175^{\circ} \mathrm{C}$, $V_{\mathrm{CE}}=400 \mathrm{~V}, \mathrm{~V}_{\mathrm{GE}}=0 / 15 \mathrm{~V}, r_{\mathrm{G}}=15 \Omega$, Dynamic test circuit in Figure E)

$T_{\mathrm{J}}$, JUNCTION TEMPERATURE
Figure 11. Typical switching times as a function of junction temperature (inductive load, $V_{C E}=400 \mathrm{~V}$,
$\mathrm{V}_{\mathrm{GE}}=0 / 15 \mathrm{~V}, I_{\mathrm{C}}=15 \mathrm{~A}, r_{\mathrm{G}}=15 \Omega$, Dynamic test circuit in Figure E)

$R_{\mathrm{G}}$, GATE RESISTOR
Figure 10. Typical switching times as a function of gate resistor (inductive load, $T_{J}=175^{\circ} \mathrm{C}$, $V_{\mathrm{CE}}=400 \mathrm{~V}, \mathrm{~V}_{\mathrm{GE}}=0 / 15 \mathrm{~V}, I_{\mathrm{C}}=15 \mathrm{~A}$, Dynamic test circuit in Figure E)

$T_{\mathrm{J}}$, JUNCTION TEMPERATURE
Figure 12. Gate-emitter threshold voltage as a function of junction temperature
$\left(I_{\mathrm{C}}=0.21 \mathrm{~mA}\right)$

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$I_{C}$, COLLECTOR CURRENT
Figure 13. Typical switching energy losses as a function of collector current (inductive load, $T_{\mathrm{J}}=175^{\circ} \mathrm{C}$,
$V_{\text {CE }}=400 \mathrm{~V}, V_{G E}=0 / 15 \mathrm{~V}, r_{G}=15 \Omega$, Dynamic test circuit in Figure E)


Figure 15. Typical switching energy losses as a function of junction temperature
(inductive load, $V_{C E}=400 \mathrm{~V}$,
$V_{G E}=0 / 15 \mathrm{~V}, I_{C}=15 \mathrm{~A}, r_{G}=15 \Omega$,
Dynamic test circuit in Figure E)


Figure 14. Typical switching energy losses as a function of gate resistor (inductive load, $T_{J}=175^{\circ} \mathrm{C}$,
$V_{C E}=400 \mathrm{~V}, \mathrm{~V}_{\mathrm{GE}}=0 / 15 \mathrm{~V}, I_{\mathrm{C}}=15 \mathrm{~A}$, Dynamic test circuit in Figure E)

$V_{\text {CE }}$, COLLECTOR-EMITTER VOLTAGE
Figure 16. Typical switching energy losses as a function of collector emitter voltage
(inductive load, $T_{J}=175^{\circ} \mathrm{C}$,
$V_{G E}=0 / 15 \mathrm{~V}, I_{C}=15 \mathrm{~A}, r_{G}=15 \Omega$,
Dynamic test circuit in Figure E)


Figure 17. Typical gate charge
( $I_{C}=15 \mathrm{~A}$ )

$V_{\text {GE }}$, GATE-EMITTETR VOLTAGE
Figure 19. Typical short circuit collector current as a function of gateemitter voltage
( $V_{\text {CE }} \leq 400 \mathrm{~V}, T_{\mathrm{j}} \leq 150^{\circ} \mathrm{C}$ )

$V_{\text {CE }}$, COLLECTOR-EMITTER VOLTAGE
Figure 18. Typical capacitance as a function of collector-emitter voltage
( $V_{\mathrm{GE}}=0 \mathrm{~V}, f=1 \mathrm{MHz}$ )


Figure 20. Short circuit withstand time as a function of gate-emitter voltage
( $V_{\text {CE }}=400 \mathrm{~V}$, start at $T_{J}=25^{\circ} \mathrm{C}$,
$\left.T_{\text {Jmax }}<150^{\circ} \mathrm{C}\right)$

## IKP15N60T

## TRENCHSTOP ${ }^{\text {TM }}$ Series



Figure 21. IGBT transient thermal
impedance
( $D=t_{\mathrm{p}} / T$ )


Figure 23. Typical reverse recovery time as a function of diode current slope ( $V_{\mathrm{R}}=400 \mathrm{~V}, I_{\mathrm{F}}=15 \mathrm{~A}$,
Dynamic test circuit in Figure E)


Figure 22. Diode transient thermal impedance as a function of pulse width
( $D=t_{\mathrm{p}} / T$ )

$d i_{\mathrm{F}} / d t$, DIODE CURRENT SLOPE
Figure 24. Typical reverse recovery charge as a function of diode current slope
( $V_{\mathrm{R}}=400 \mathrm{~V}, I_{\mathrm{F}}=15 \mathrm{~A}$,
Dynamic test circuit in Figure E)


Figure 25. Typical reverse recovery current as a function of diode current slope
( $V_{\mathrm{R}}=400 \mathrm{~V}, I_{\mathrm{F}}=15 \mathrm{~A}$,
Dynamic test circuit in Figure E)

$d i_{\mathrm{F}} / d t$, DIODE CURRENT SLOPE
Figure 26. Typical diode peak rate of fall of reverse recovery current as a function of diode current slope ( $V_{\mathrm{R}}=400 \mathrm{~V}, I_{\mathrm{F}}=15 \mathrm{~A}$,
Dynamic test circuit in Figure E)

$V_{\mathrm{F}}$, FORWARD VOLTAGE
Figure 27. Typical diode forward current as a function of forward voltage

$T_{\mathrm{J}}$, JUNCTION TEMPERATURE
Figure 28. Typical diode forward voltage as a function of junction temperature

IKP15N60T

PG-TO220-3



Figure A. Definition of switching times


Figure C. Definition of diodes switching characteristics


Figure D. Thermal equivalent circuit


Figure E, Dynamic test circuit Parasitic inductance $\mathrm{L}_{\sigma}$,
Parasitic capacitor $\mathrm{C}_{\sigma}$,
Relief capacitor $\mathrm{C}_{\mathrm{r}}$
(only for ZVT switching)

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IXA30RG1200DHGLB IXA40RG1200DHGLB APT70GR65B2DU40 NTE3320 IHFW40N65R5SXKSA1 APT70GR120J APT35GP120JDQ2 IKZA40N65RH5XKSA1 IKFW75N65ES5XKSA1 IKFW50N65ES5XKSA1 IKFW50N65EH5XKSA1 IKFW40N65ES5XKSA1 IKFW60N65ES5XKSA1 IMBG120R090M1HXTMA1 IMBG120R220M1HXTMA1 XD15H120CX1 XD25H120CX0 XP15PJS120CL1B1 IGW30N60H3FKSA1 STGWA8M120DF3 IGW08T120FKSA1 IGW75N60H3FKSA1 HGTG40N60B3 FGH60N60SMD_F085 FGH75T65UPD STGWA15H120F2 IKA10N60TXKSA1 IHW20N120R5XKSA1 RJH60D2DPPM0\#T2 IKP20N60TXKSA1 IHW20N65R5XKSA1


[^0]:    ${ }^{1}$ J-STD-020 and JESD-022
    ${ }^{2)}$ Allowed number of short circuits: <1000; time between short circuits: >1s.

